

MOSFET

OptiMOS[™] 5 Power-Transistor, 30 V

Features

- Optimized for high performance SMPS, e.g. sync.rec. Very low on-resistance $R_{\rm DS(on)}$ @ $V_{\rm GS}$ =4.5 V 100% avalanche tested Superior thermal resistance

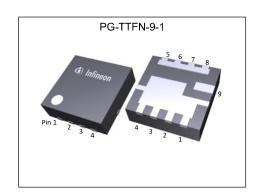
- N-channel
- Pb-free lead plating; RoHS compliant
- Halogen-free according to IEC61249-2-21

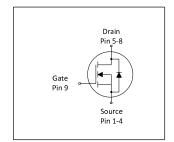
Product validation

Fully qualified according to JEDEC for Industrial Applications

Table 1 **Key Performance Parameters**

Table 1 Rey Ferformance Farameters							
Parameter	Value	Unit					
V _{DS}	30	V					
$R_{ m DS(on),max}$	0.85	m $Ω$					
I _D	253	A					
Qoss	31	nC					
Q _G (0V4.5V)	30	nC					











Type / Ordering Code	Package	Marking	Related Links
IQE008N03LM5CG	PG-TTFN-9-1	00803C5	-

OptiMOSTM 5 Power-Transistor, 30 V



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OptiMOS[™] 5 Power-Transistor, 30 V IQE008N03LM5CG



1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 **Maximum ratings**

D	0		Values			N 4 7 4 9 199
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current ¹⁾	I _D	- - -	-	253 160 27	A	V _{GS} =10 V, T _C =25 °C V _{GS} =10 V, T _C =100 °C V _{GS} =4.5V, T _A =25 °C, R _{thJA} =60 °C/W ²)
Pulsed drain current ³⁾	I _{D,pulse}	-	-	1012	Α	T _A =25 °C
Avalanche energy, single pulse ⁴⁾	E _{AS}	-	-	50	mJ	$I_{\rm D}$ =20 A, $R_{\rm GS}$ =25 Ω
Gate source voltage	V _{GS}	-16	-	16	V	-
Power dissipation	P _{tot}	-	-	89 2.1	W	T _C =25 °C T _A =25 °C, R _{thJA} =60 °C/W ²⁾
Operating and storage temperature	T _j , T _{stg}	-55	-	150	°C	IEC climatic category; DIN IEC 68-1: 55/150/56

2 Thermal characteristics

Table 3 Thermal characteristics

Parameter	Symbol	Values			l lmi4	Note / Test Condition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Thermal resistance, junction - case, bottom	R_{thJC}	_	-	1.4	°C/W	-
Device on PCB, 6 cm² cooling area	R _{thJA}	-	-	60	°C/W	-

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature environmental conditions.

2) Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 µm thick) copper area for drain connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed in as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual

See Diagram 3 for more detailed information

⁴⁾ See Diagram 13 for more detailed information

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3 Electrical characteristics at T_j =25 °C, unless otherwise specified

Table 4 **Static characteristics**

Damana dam	Course la al		Values			Nada / Taad Oan didian
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	30	-	-	V	V _{GS} =0 V, I _D =1 mA
Gate threshold voltage	V _{GS(th)}	1.2	1.6	2.0	V	V _{DS} =V _{GS} , I _D =250 μA
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1.0 100	μA	V _{DS} =24 V, V _{GS} =0 V, T _j =25 °C V _{DS} =24 V, V _{GS} =0 V, T _j =125 °C
Gate-source leakage current	I _{GSS}	-	10	100	nA	V _{GS} =20 V, V _{DS} =0 V
Drain-source on-state resistance	R _{DS(on)}	-	0.65 0.80	0.85 1.4	mΩ	V _{GS} =10 V, I _D =20 A V _{GS} =4.5 V, I _D =20 A
Gate resistance	R _G	-	0.6	-	Ω	-
Transconductance	g_{fs}	-	190	-	S	$ V_{DS} \ge 2 I_D R_{DS(on)max}, I_D = 20 A$

 Table 5
 Dynamic characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance ¹⁾	C _{iss}	-	4400	5700	pF	V _{GS} =0 V, V _{DS} =15 V, f=1 MHz
Output capacitance ¹⁾	Coss	-	1100	1400	pF	V _{GS} =0 V, V _{DS} =15 V, <i>f</i> =1 MHz
Reverse transfer capacitance ¹⁾	C _{rss}	-	110	190	pF	V _{GS} =0 V, V _{DS} =15 V, <i>f</i> =1 MHz
Turn-on delay time	$t_{\sf d(on)}$	_	18.6	-	ns	$V_{\rm DD}$ =15 V, $V_{\rm GS}$ =4.5 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 Ω
Rise time	t _r	-	37.7	-	ns	$V_{\rm DD}$ =15 V, $V_{\rm GS}$ =4.5 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 Ω
Turn-off delay time	$t_{ m d(off)}$	_	32.3	-	ns	$V_{\rm DD}$ =15 V, $V_{\rm GS}$ =4.5 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 Ω
Fall time	t _f	-	9.3	-	ns	$V_{\rm DD}$ =15 V, $V_{\rm GS}$ =4.5 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 Ω

Gate charge characteristics²⁾ Table 6

Davamatav	Sumb al	Values			11:4	Nata / Tast Candition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q _{gs}	-	10	-	nC	V_{DD} =15 V, I_{D} =20 A, V_{GS} =0 to 4.5 V
Gate charge at threshold	$Q_{g(th)}$	-	6	-	nC	V_{DD} =15 V, I_{D} =20 A, V_{GS} =0 to 4.5 V
Gate to drain charge ¹⁾	$Q_{ m gd}$	-	6	9	nC	V_{DD} =15 V, I_{D} =20 A, V_{GS} =0 to 4.5 V
Switching charge	Q _{sw}	-	10	-	nC	V_{DD} =15 V, I_{D} =20 A, V_{GS} =0 to 4.5 V
Gate charge total ¹⁾	Q_{g}	-	30	37	nC	V_{DD} =15 V, I_{D} =20 A, V_{GS} =0 to 4.5 V
Gate plateau voltage	V _{plateau}	-	2.3	-	V	V_{DD} =15 V, I_{D} =20 A, V_{GS} =0 to 4.5 V
Gate charge total	Q_{g}	-	64	-	nC	V _{DD} =15 V, I _D =20 A, V _{GS} =0 to 10 V
Output charge ¹⁾	Qoss	_	31	41	nC	V _{DS} =15 V, V _{GS} =0 V

Defined by design. Not subject to production test.
See "Gate charge waveforms" for parameter definition

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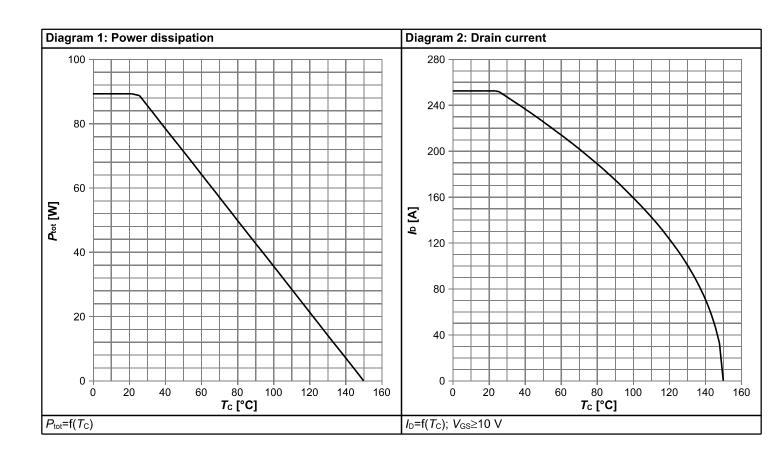


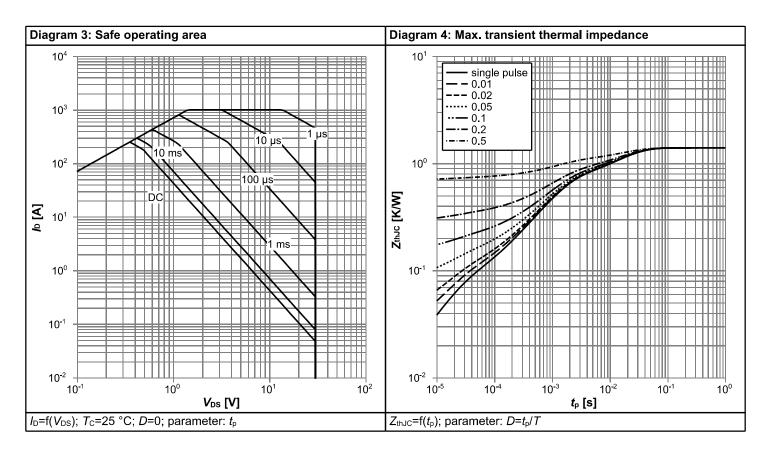
Table 7 Reverse diode

Dovomotov	Symbol	Values			11	Nata / Tant Candition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode continuous forward current	Is	-	-	81	Α	<i>T</i> _C =25 °C
Diode pulse current	I _{S,pulse}	-	-	1012	Α	T _C =25 °C
Diode forward voltage	V _{SD}	-	0.73	1.0	V	V _{GS} =0 V, I _F =20 A, T _j =25 °C
Reverse recovery charge ¹⁾	Qrr	-	27	54	nC	V _R =15 V, I _F =20 A, d <i>i</i> _F /d <i>t</i> =100 A/μs

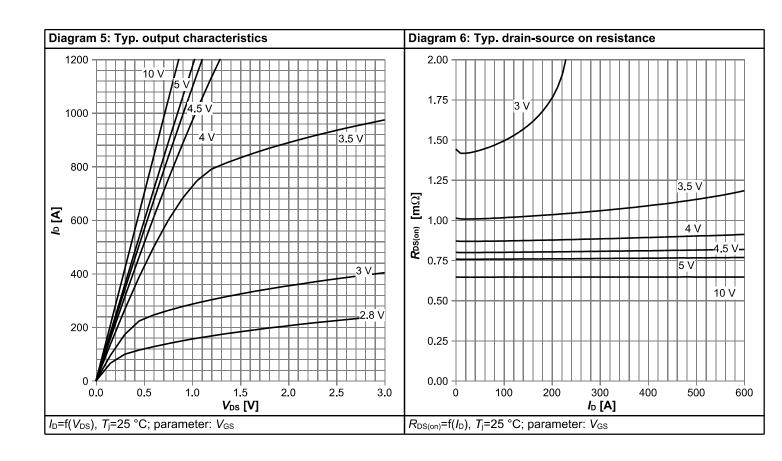


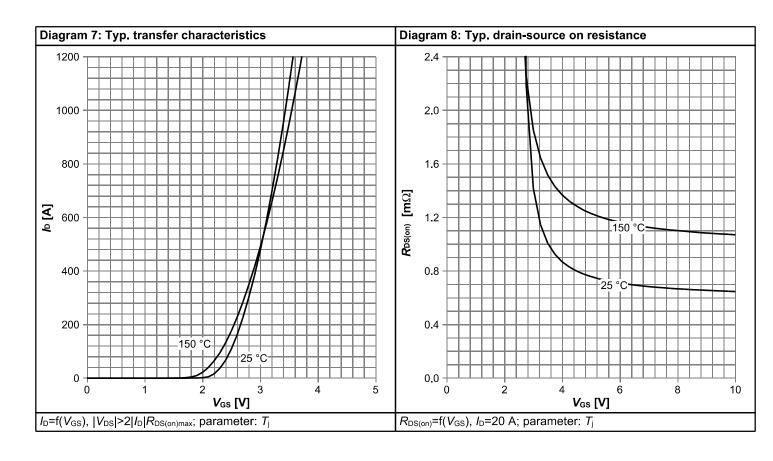
4 Electrical characteristics diagrams



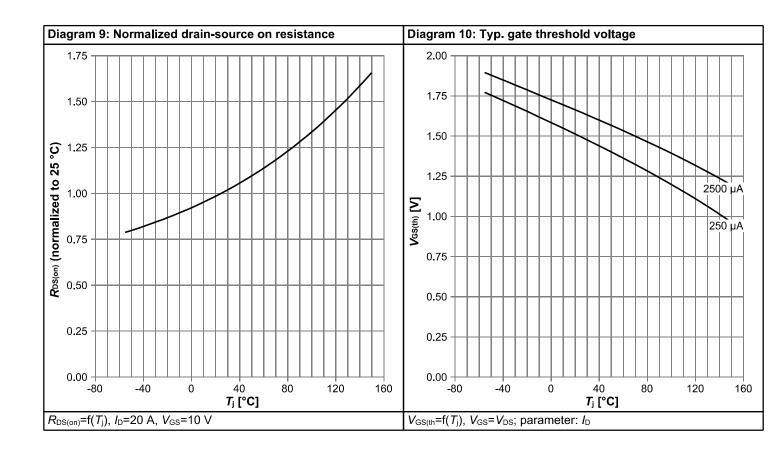


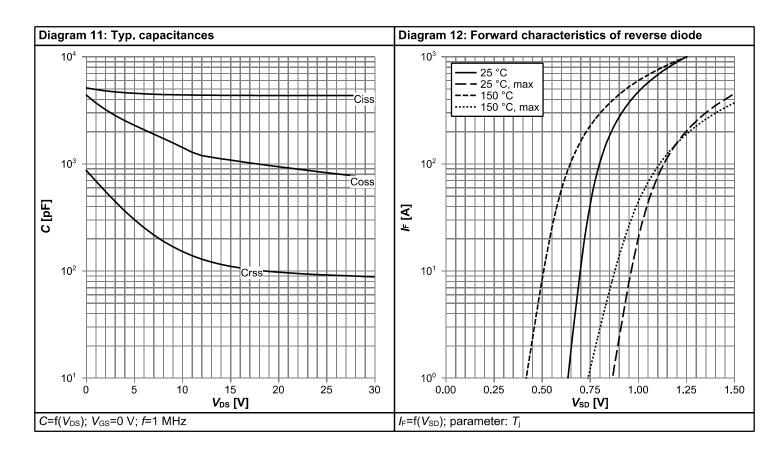




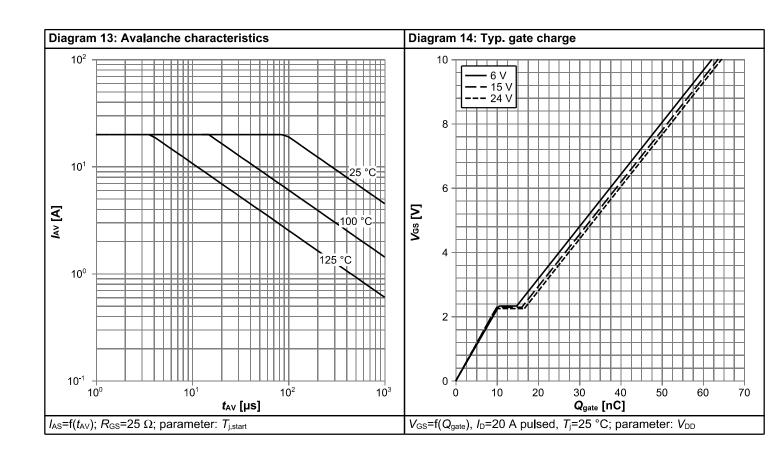


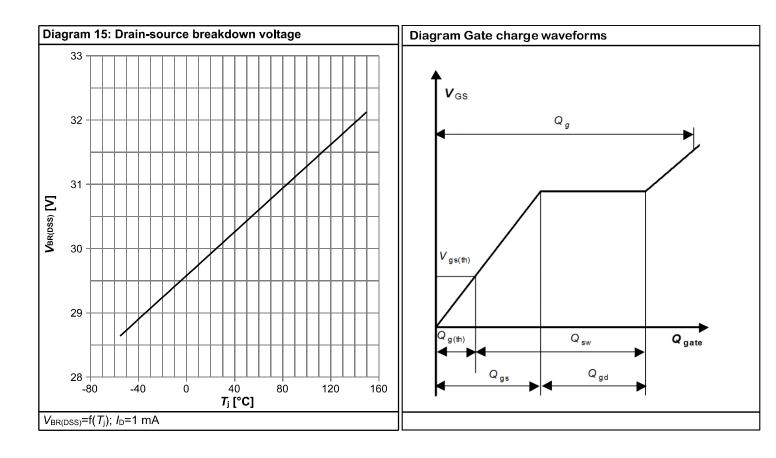






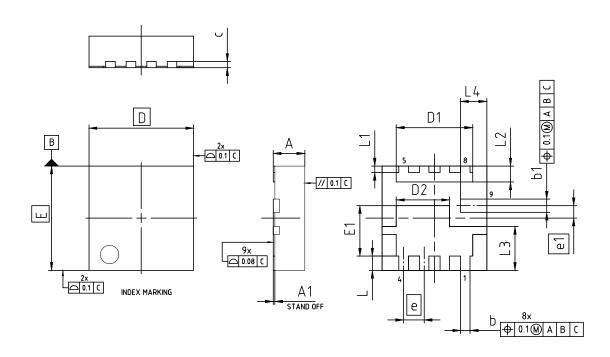








5 Package Outlines



DIMENSION	MILLIMETERS						
DIMENSION	MIN.	MAX.					
Α	-	1.10					
A1	-	0.05					
b	0.20	0.40					
b1	0.32	0.52					
С	0.	20					
D	3.30						
D1	2.31	2.51					
D2	1.58	1.78					
E	3.30						
E1	1.50	1.70					
е	0.65						
e1	0.395						
L	0.35	0.55					
L1	0.10	0.30					
L2	0.40	0.60					
L3	1.285	1.485					
L4	0.73	0.93					

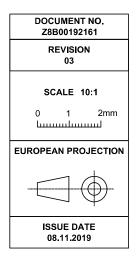


Figure 1 Outline PG-TTFN-9-1, dimensions in mm



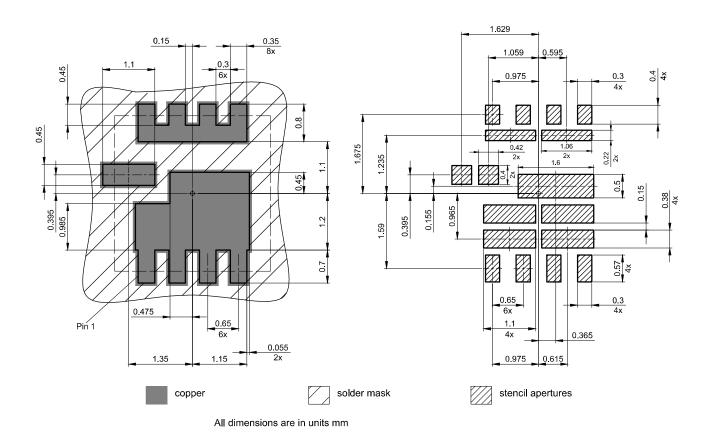


Figure 2 Outline Boardpad (PG-TTFN-9-1), dimensions in mm

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Revision History

IQE008N03LM5CG

Revision: 2021-04-28, Rev. 2.0

Previous Revision

Revision	Date	Subjects (major changes since last revision)
2.0	2021-04-28	Release of final version

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